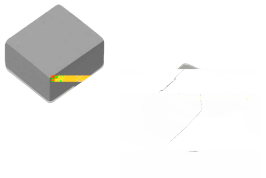
Wire Wound Molded SMD Power Inductors
Size 25201B



- {ƨĎ ăl·űdzNl·əƨy
- l λƎK ŎdzNNŜyűžƒƨø 5/wƵKλƎK ŜŶŎλŜyŎè
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- l λƎK NJŜfλl·ōλfλúè
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- hLJŜNl·əyƎ űŜYˊLJŜNl·űdzNJŜ ππлЧЬмнр ℃ óLyŎfdzŘλyƎ ăŜfŦ π űŜYˊLJŜNl·űdzNJŜ NJăŜú
- vdzl·yəűèY олллLJŎă

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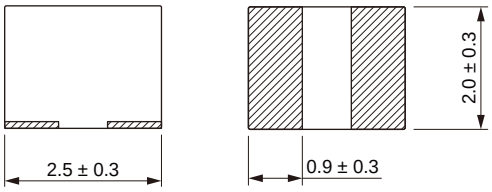
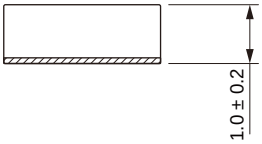
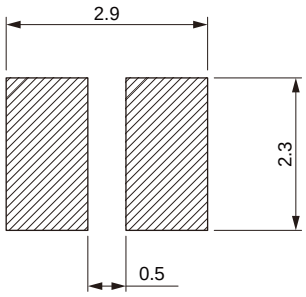
- 5/κ5/ ŎƨyØŜNJúŜN

Dimensions: [mm]





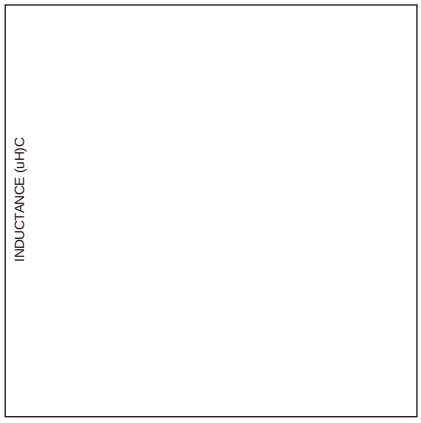
Land Pattern: [mm]



Part No	Inductance @ 1MHz/1V	Tolerance	Current Typ.	Current Max.	Temperature Rise Current Typ.	Temperature Rise Current Max.	DC Resistance Max.

Saturation Current will cause L to drop approximately 30%
Temperature Rise Current: The actual value of DC current when the temperature rise is △T=40°C

Typical Electrical Characteristics:



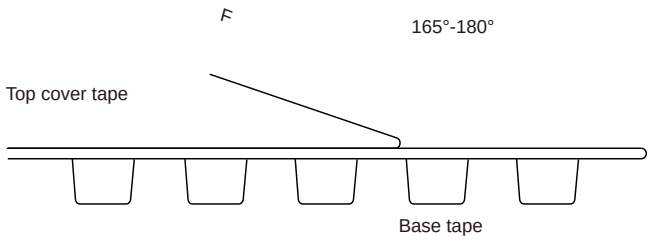
Soldering Reflow:

Packaging Information:

Tape Dimension:

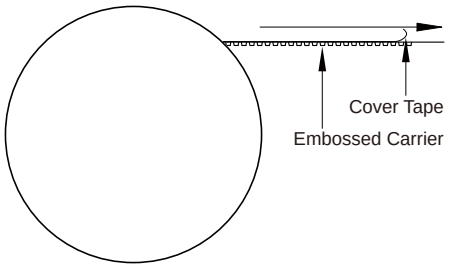
Series	A0 (mm)	B0 (mm)
MDTE25201B		

Peel force of top cover tape:



The peel force of top cover tape shall be betw os

Reel Dimension：[mm]



Packaging Quantity: